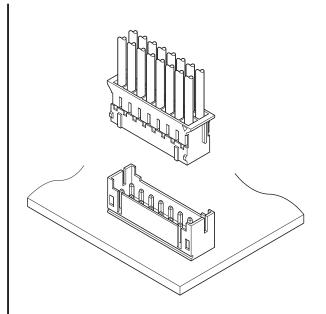


PHD CONNECTOR

2.0 mm pitch/Wire-to-Board connectors/Crimp style and Mating style



This is a 2.0 mm pitch wire-to-board connector with dual-row structure. In mounting height of 8.8 mm and depth of 5 mm, this connector realizes low profile and space-saving, and supports a compact and high densification of equipment.

- · Low profile and space-saving design
- · High reliability contact
- Fully shrouded header

Standards

Recognized E60389

Specifications

- Current rating: 3 A AC/DC (AWG #22)
- Voltage rating: 250 V AC/DC
- Temperature range: -25°C to +85°C

(including temperature rise in applying electrical current)

· Contact resistance:

Initial value/ $10 \text{ m}\Omega$ max.

After environmental tests/ 20 m Ω max.

- Insulation resistance: 1,000 M Ω min.
- · Withstanding voltage:

There shall be no breakdown or flashover while applying 800 VAC for one minute.

· Applicable wire range:

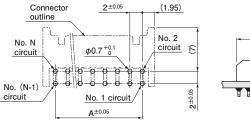
Conductor size/ AWG #28 to AWG #22 Insulation O.D./ ϕ 0.9 mm to ϕ 1.5 mm

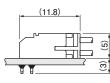
- Applicable PC board thickness: 1.6 mm
- * In using the products, refer to "Handling Precautions for Terminals and Connectors" described on our website (Technical documents of Product information page).
- * RoHS2 compliance
- * Dimensional unit: mm
- * Contact JST for details.

PC board layout and Assembly layout

Top entry type

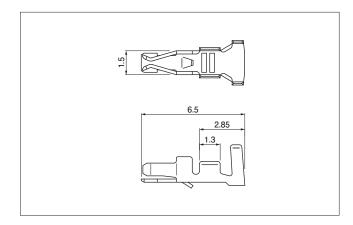
Side entry type





- Note: 1. The figure of PC board layout is the figure viewed from the connector mounting side.
 - 2. Dimension A: See "Header" section on page 3.
 - 3. Tolerance for the PCB hole pitch shall be \pm 0.05, and shall not accumulate more than \pm 0.05.
 - 4. Hole dimensions differ according to the type of PC board and piercing method. Larger hole diameters are required when using the hard material such as glass fabric PC board.
 - 5. The above dimensions are reference values. Please contact JST for details.

Contact



Model No.	Applicable wire range		
Model No.	Conductor size AWG (mm²)	Insulation O.D. (mm)	reel
SPHD-002T-P0.5	#28 to #24 (0.08 to 0.21)	0.9 to 1.5	0 000
SPHD-001T-P0.5	#26 to #22 (0.13 to 0.33)	1.0 to 1.5	8,000

Material and Surface finish, etc.

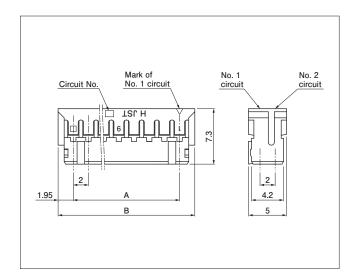
Phosphor bronze, tin-plated

Crimping machine

Contact	Crimping machine	Applicator	Crimp applicator with dies
SPHD-002T-P0.5	AP-K2N	MKS-L-10	APLMK SPHD002-05
SPHD-001T-P0.5	AF-NZIN	IVIING-L-10	APLMK SPHD001-05

Note: Contact JST for fully automatic crimping applicator.

Socket housing

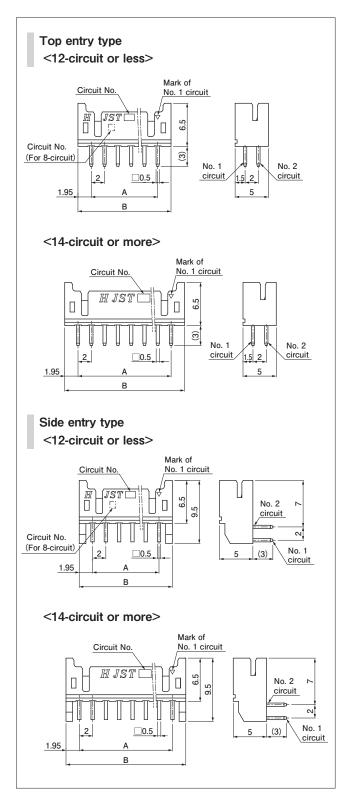


No. of circuits	Model No.	Dimensions (mm)		O'tu/baa	
	wiodei No.	Α	В	Q'ty/bag	
8	PHDR-08VS	6.0	9.9	1,000	
10	PHDR-10VS	8.0	11.9	1,000	
12	PHDR-12VS	10.0	13.9	1,000	
14	PHDR-14VS	12.0	15.9	1,000	
16	PHDR-16VS	14.0	17.9	1,000	
18	PHDR-18VS	16.0	19.9	1,000	
20	PHDR-20VS	18.0	21.9	1,000	
22	PHDR-22VS	20.0	23.9	1,000	
24	PHDR-24VS	22.0	25.9	1,000	
26	PHDR-26VS	24.0	27.9	1,000	
28	PHDR-28VS	26.0	29.9	1,000	
30	PHDR-30VS	28.0	31.9	1,000	
32	PHDR-32VS	30.0	33.9	1,000	
34	PHDR-34VS	32.0	35.9	1,000	

Material and Surface finish, etc.

PA 66, UL94V-0, natural (white)

Header



Top entry type

No. of circuits	Model No.		Dimensions (mm)		0'+./
	PA 66 (Glass-filled)	PA 66	Α	В	Q'ty/ box
8	B8B-PHDSS	_	6.0	9.9	500
10	B10B-PHDSS	B10B-PHDSS-B	8.0	11.9	500
12	B12B-PHDSS	B12B-PHDSS-B	10.0	13.9	500
14	B14B-PHDSS	B14B-PHDSS-B	12.0	15.9	500
16	B16B-PHDSS	B16B-PHDSS-B	14.0	17.9	500
18	B18B-PHDSS	B18B-PHDSS-B	16.0	19.9	500
20	B20B-PHDSS	B20B-PHDSS-B	18.0	21.9	250
22	B22B-PHDSS	B22B-PHDSS-B	20.0	23.9	250
24	B24B-PHDSS	B24B-PHDSS-B	22.0	25.9	250
26	B26B-PHDSS	B26B-PHDSS-B	24.0	27.9	250
28	B28B-PHDSS	B28B-PHDSS-B	26.0	29.9	250
30	B30B-PHDSS	B30B-PHDSS-B	28.0	31.9	250
32	B32B-PHDSS	B32B-PHDSS-B	30.0	33.9	250
34	B34B-PHDSS	B34B-PHDSS-B	32.0	35.9	250

Material and Surface finish, etc.

Post: Copper alloy, copper-undercoated, tin-plated Wafer: PA 66 (Glass-filled), UL94V-0, natural (ivory) PA 66, UL94V-0, natural (white)

Note: This product displays (LF) (SN) on a label.

Side entry type

No. of circuits	Model No.		Dimensions (mm)		O'+/
	PA 66 (Glass-filled)	PA 66	Α	В	Q'ty/ box
8	S8B-PHDSS	_	6.0	9.9	500
10	S10B-PHDSS	S10B-PHDSS-B	8.0	11.9	500
12	S12B-PHDSS	S12B-PHDSS-B	10.0	13.9	500
14	S14B-PHDSS	S14B-PHDSS-B	12.0	15.9	250
16	S16B-PHDSS	S16B-PHDSS-B	14.0	17.9	250
18	S18B-PHDSS	S18B-PHDSS-B	16.0	19.9	250
20	S20B-PHDSS	S20B-PHDSS-B	18.0	21.9	250
22	S22B-PHDSS	S22B-PHDSS-B	20.0	23.9	250
24	S24B-PHDSS	S24B-PHDSS-B	22.0	25.9	200
26	S26B-PHDSS	S26B-PHDSS-B	24.0	27.9	200
28	S28B-PHDSS	S28B-PHDSS-B	26.0	29.9	200
30	S30B-PHDSS	S30B-PHDSS-B	28.0	31.9	200
32	S32B-PHDSS	S32B-PHDSS-B	30.0	33.9	200
34	S34B-PHDSS	S34B-PHDSS-B	32.0	35.9	200

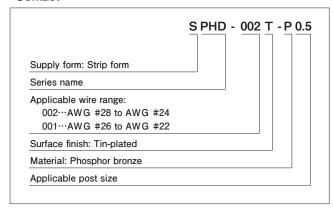
Material and Surface finish, etc.

Post: Copper alloy, copper-undercoated, tin-plated Wafer: PA 66 (Glass-filled), UL94V-0, natural (ivory) PA 66, UL94V-0, natural (white)

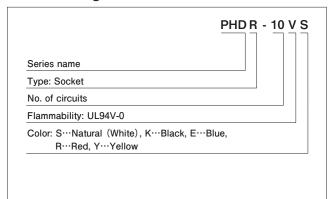
Note: This product displays (LF) (SN) on a label.

Model number allocation

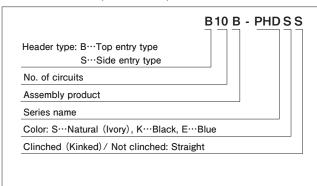
Contact



Socket housing



Header/ PA 66 (Glass-filled)



Header/ PA 66

